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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	S1C17
Core Size	16-Bit
Speed	16.8MHz
Connectivity	I <sup>2</sup> C, IrDA, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	38
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x12b SAR
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/epson/s1c17m13f101100-250

# S1C17M12/M13 (rev1.0)



### **16-bit Single Chip Microcontroller**

- 16KB Flash ROM: Read/program protection function, 2KB RAM
- Supports 1.8V to 5.5V wide range operating voltage.
- Five-digit seven-segment LED controller (8SEG × 1–5COM (max.))
- Supports various kinds of interfaces (UART, SPI, I<sup>2</sup>C)

#### **■ DESCRIPTIONS**

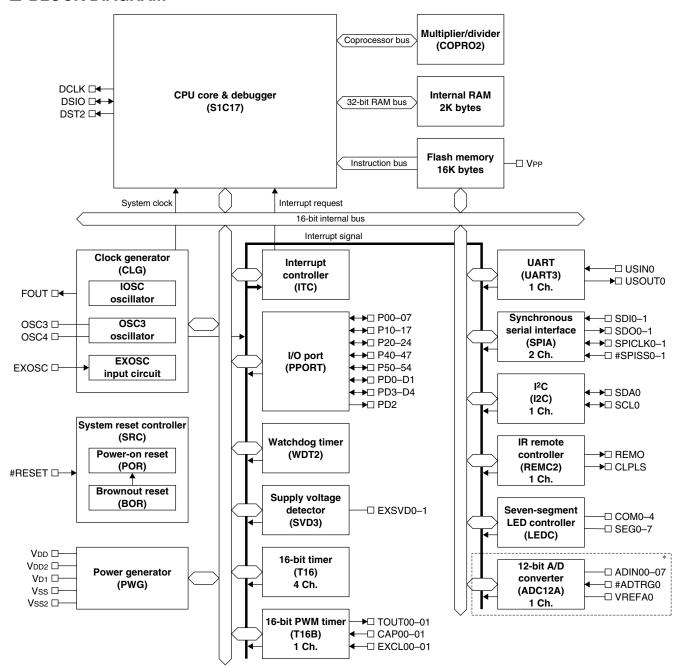
The S1C17M12/M13 is a 16-bit embedded Flash MCU that features low power consumption. It includes various serial interfaces and a seven-segment LED controller on the compact die. It is suitable for control panels with a seven-segment display for housing equipment and FA equipment.

#### **■ FEATURES**

Model	S1C17M12	S1C17M13
CPU		
CPU core	Seiko Epson original 16-bit RISC CPU core S	S1C17
Other	On-chip debugger	
Embedded Flash memory		
Capacity	16K bytes (for both instructions and data)	
Erase/program count	1,000 times (min.)	
Other	Security function to protect from reading/pro	gramming by ICDmini
	On-board programming function using ICDm	ini
Embedded RAM		
Capacity	2K bytes	
Clock generator (CLG)		
System clock source	3 sources (IOSC/OSC3/EXOSC)	
System clock frequency (operating frequency)	16.8 MHz (max.)	
IOSC oscillator circuit (boot clock source)	700 kHz (typ.) embedded oscillator	
	23 µs (max.) starting time (time from cancelate	tion of SLEEP state to vector table read by
	the CPU)	
OSC3 oscillator circuit	16.8 MHz (max.) crystal/ceramic oscillator	
	4, 8, 12, and 16 MHz-switchable embedded	oscillator
EXOSC clock input	16.8 MHz (max.) square or sine wave input	
Other	Configurable system clock division ratio	
	Configurable system clock used at wake up	
	Operating clock frequency for the CPU and a	all peripheral circuits is selectable.
I/O port (PPORT)		
Number of general-purpose I/O ports	Input/output port: 38 bits (max.)	
	Output port: 1 bit (max.)	
	Pins are shared with the peripheral I/O.	
Number of input interrupt ports	34 bits (max.)	
Number of ports that support universal port	21 bits	
multiplexer (UPMUX)	A peripheral circuit I/O function selected via	software can be assigned to each port.
Number of high drive-capability Nch outputs	8 bits (max.)	
	7 mA output (max.)	
Number of high drive-capability Pch outputs	5 bits (max.)	
	56 mA output (max., Total sum of 5 bits)	
Timers		
Watchdog timer (WDT2)	Generates NMI or watchdog timer reset.	
	Programmable NMI/reset generation cycle	
16-bit timer (T16)	4 channels	
	Generates the SPIA master clock and the AD	OC12A trigger signal.
16-bit PWM timer (T16B)	1 channel	
	Event counter/capture function	
	PWM waveform generation function	
	Number of PWM output or capture input por	ts: 2 ports/channel
Supply voltage detector (SVD3)		
Detection voltage	VDD or external voltage (two external voltage	
Detection level	VDD: 28 levels (1.8 to 5.0 V)/external voltage:	32 levels (1.2 to 5.0 V)
Other	Intermittent operation mode	
	Generates an interrupt or reset according to	the detection level evaluation.

Model	S1C17M12	S1C17M13			
	SICIAMIZ	SICITMIS			
Serial interfaces	A channels				
UART (UART3)	4 channels				
	Baud-rate generator included, IrDA				
		and baud rate division ratio are configurable.			
	Infrared communication carrier mo	dulation output function			
Serial interfaces	T				
Synchronous serial interface (SPIA)	2 channels				
	2 to 16-bit variable data length				
		for the baud-rate generator in master mode.			
I <sup>2</sup> C (I2C)	1 channel				
	Baud-rate generator included				
IR remote controller (REMC2)					
Number of transmitter channels	1 channel				
Other	EL lamp drive waveform can be ge	nerated for an application example.			
Seven-segment LED controller (LEDC)	<u> </u>				
LED control output	Seven-segment LED outputs up to	five digits (8SEG $\times$ 1–5COM(max.))			
	COM time-division dynamic drive of	control			
	Software configurable anode/catho	ode common mode and off-state pin status			
	Four-level brightness adjustment fu	unction			
12-bit A/D converter (ADC12A)					
Conversion method	-	Successive approximation type			
Resolution		12 bits			
Number of conversion channels		1 channel			
Number of analog signal inputs		8 ports/channel			
Multiplier/divider (COPRO2)					
Arithmetic functions	16-bit × 16-bit multiplier				
	16-bit × 16-bit + 32-bit multiply and	d accumulation unit			
	32-bit ÷ 32-bit divider				
Reset					
#RESET pin	Reset when the reset pin is set to le	OW.			
Power-on reset	Reset at power on.				
Brownout reset	Reset when the power supply volta	age drops.			
Key entry reset		03 keys are pressed simultaneously (can be enabled/			
,,	disabled using a register).				
Watchdog timer reset	· · · · · · · · · · · · · · · · · · ·	rerflows (can be enabled/disabled using a register).			
Supply voltage detector reset		ector detects the set voltage level (can be enabled/dis-			
1 2 4 4 5 5 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6	abled using a register).	3 (			
Interrupt	, , , , , , , , , , , , , , , , , , ,				
Non-maskable interrupt	4 systems (Reset, address misalign	ned interrupt, debug, NMI)			
Programmable interrupt	External interrupt: 1 system (8 leve				
	Internal interrupt: 14 systems (8 le				
Power supply voltage		,			
V <sub>DD</sub> operating voltage	1.8 to 5.5 V				
VDD operating voltage for Flash programi		ower supply is required.)			
Operating temperature	5, 10 12 112 1 (11. 7.10 1 0.00) mar pr				
Operating temperature range	-40 to 85 °C				
Current consumption (Typ. value)	1 .0 .0 00				
SLEEP mode	0.5 μA (TBD)				
OLLE MOGE	IOSC = OFF, OSC3 = OFF				
HALT mode	180 µA (TBD)				
TO LET THOUS	OSC3 = 4 MHz (internal oscillator)				
RUN mode	600 μA (TBD)				
Tion Tillouc	OSC3 = 4 MHz (internal oscillator),	CPU = OSC3 (1 wait cycle)			
	1,700 µA (TBD)	or o = 5000 (1 wait by oro)			
	OSC3 = 16 MHz (internal oscillator)	), CPU = OSC3 (2 wait cycles)			
Shipping form	10000 - 10 Mil iz (internal oscillator)	,, o. 5 – 5555 (2 wait by 5105)			
1	TQFP12-48pin (Lead pitch: 0.5 mm	n)			
<u>'</u>	practice topin (Leau pilon, 0.3 illin	<i>'</i> /			

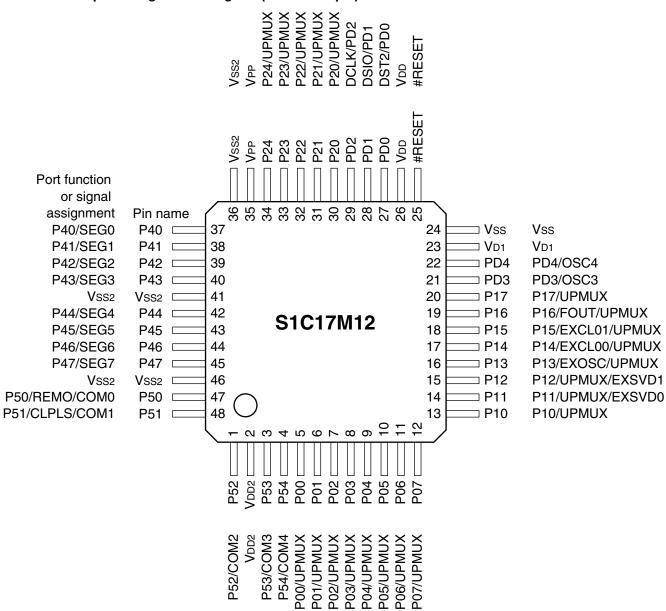
#### **■ BLOCK DIAGRAM**

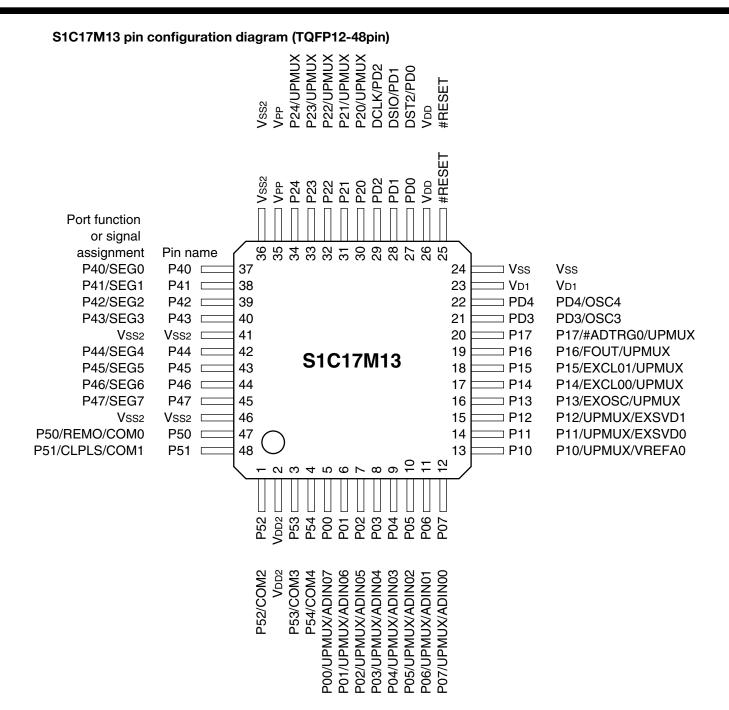


\* Not available in the S1C17M12.

#### **■ PIN CONFIGURATION DIAGRAMS**

S1C17M12 pin configuration diagram (TQFP12-48pin)





#### **■ PIN DESCRIPTIONS**

#### Symbol meanings

Assigned signal: The signal listed at the top of each pin is assigned in the initial state. The pin function must be

switched via software to assign another signal (see the "I/O Ports" chapter).

I/O: I = Input

O = Output
I/O = Input/output
P = Power supply
A = Analog signal

Hi-Z = High impedance state

Initial state: I (Pull-up) = Input with pulled up

I (Pull-down) = Input with pulled down
Hi-Z = High impedance state
O (H) = High level output
O (L) = Low level output

Tolerant fail-safe structure:

= Over voltage tolerant fail-safe type I/O cell included (see the "I/O Ports" chapter)

The over voltage tolerant fail-safe type I/O cell allows interfacing without passing unnecessary current even if a voltage exceeding V<sub>DD</sub> is applied to the port. Also unnecessary current is not consumed when the port is externally biased without supplying V<sub>DD</sub>.

Pin/pad name	Assigned signal	I/O	Initial state	Tolerant fail-safe structure	Function	S1C17M12	111111	S1C17M13
V <sub>DD</sub>	V <sub>DD</sub>	Р	_	_	Power supply (+), I/O power supply (except for P50–54)	/	7	7
V <sub>DD2</sub>	V <sub>DD2</sub>	Р	_	_	I/O power supply (P50–54)	1	7	/
Vss	Vss	Р	_	_	GND (except for P40–47, P50–54)	1	7	/
Vss2	Vss2	Р	_	_	GND (P40-47, P50-54)	/	7	/
VPP	VPP	Р	_	_	Power supply for Flash programming	/	7	/
V <sub>D1</sub>	V <sub>D1</sub>	Α	_	_	V <sub>D1</sub> regulator output	/	7	/
#RESET	#RESET	ī	I (Pull-up)	_	Reset input	/	$\rightarrow$	_
P00	P00	1/0	Hi-Z	_	I/O port	/	-	/
	UPMUX	1/0			User-selected I/O (universal port multiplexer)	/	-	/
	ADIN07	A	-		12-bit A/D converter Ch.0 analog signal input 7		-	/
P01	P01	1/0	Hi-Z	_	I/O port		+	<u>'</u>
101	UPMUX	1/0			User-selected I/O (universal port multiplexer)		$\rightarrow$	<u>/</u>
	ADIN06	Α	-		12-bit A/D converter Ch.0 analog signal input 6		-	/
P02	P02	1/0	Hi-Z		I/O port		+	<u>/</u>
FU2	UPMUX	1/0	⊓1-∠	_	User-selected I/O (universal port multiplexer)	<i>'</i>	-	✓ ✓
	ADIN05	A					+	✓ ✓
Doo			11: 7		12-bit A/D converter Ch.0 analog signal input 5	-	_	•
P03	P03	1/0	Hi-Z	_	I/O port	<b>✓</b>	-	<u>/</u>
	UPMUX	1/0			User-selected I/O (universal port multiplexer)	<b>✓</b>	$\rightarrow$	<u>/</u>
<b></b>	ADIN04	A			12-bit A/D converter Ch.0 analog signal input 4	-	-	<u>/</u>
P04	P04	1/0	Hi-Z	_	I/O port	<b>✓</b>	-	/
	UPMUX	I/O			User-selected I/O (universal port multiplexer)	<b>✓</b>	+	✓
	ADIN03	Α			12-bit A/D converter Ch.0 analog signal input 3	-	+	✓
P05	P05	I/O	Hi-Z	_	I/O port	<b>✓</b>	+	✓
	UPMUX	I/O			User-selected I/O (universal port multiplexer)	<b>✓</b>	$\rightarrow$	✓
	ADIN02	Α			12-bit A/D converter Ch.0 analog signal input 2	-	-	/
P06	P06	I/O	Hi-Z	_	I/O port	✓	1	✓
	UPMUX	I/O			User-selected I/O (universal port multiplexer)	✓		/
	ADIN01	Α			12-bit A/D converter Ch.0 analog signal input 1		-	/
P07	P07	I/O	Hi-Z	_	I/O port	1		/
	UPMUX	I/O	]		User-selected I/O (universal port multiplexer)	1	7	/
	ADIN00	Α			12-bit A/D converter Ch.0 analog signal input 0	-	-T	/
P10	P10	I/O	Hi-Z	_	I/O port	1	7	/
	UPMUX	I/O	1		User-selected I/O (universal port multiplexer)	1	7	/
	VREFA0	Α	1		12-bit A/D converter Ch.0 reference voltage input	-	-	/
P11	P11	I/O	Hi-Z	_	I/O port	1	7	/
	UPMUX	1/0	_		User-selected I/O (universal port multiplexer)	/	+	/
	EXSVD0	A	1		External power supply voltage detection input Ch.0	1/	+	7

Pin/pad name	Assigned signal	I/O	Initial state	Tolerant fail-safe structure	Function		S1C17M12	S1C17M13
P12	P12	1/0	Hi-Z	_	I/O port		1	1
1 12	UPMUX	1/0	2		User-selected I/O (universal port multiplexer)		1	1
	EXSVD1	Α			External power supply voltage detection input	Ch.1	1	1
P13	P13	I/O	Hi-Z	_	I/O port		1	1
	EXOSC	ı			Clock generator external clock input		1	1
	UPMUX	1/0	ĺ		User-selected I/O (universal port multiplexer)		1	1
P14	P14	I/O	Hi-Z	_	I/O port		1	1
	EXCL00	ı			16-bit PWM timer Ch.0 event counter input 0		1	1
	UPMUX	I/O			User-selected I/O (universal port multiplexer)		1	1
P15	P15	I/O	Hi-Z	_	I/O port		1	1
	EXCL01	I			16-bit PWM timer Ch.0 event counter input 1		1	1
	UPMUX	I/O			User-selected I/O (universal port multiplexer)		1	1
P16	P16	I/O	Hi-Z	_	I/O port		1	1
	FOUT	0	]		Clock external output		1	1
	UPMUX	I/O	]		User-selected I/O (universal port multiplexer)		1	1
P17	P17	I/O	Hi-Z	_	I/O port		1	1
	#ADTRG0	ı	]		12-bit A/D converter Ch.0 trigger input		-	1
	UPMUX	I/O			User-selected I/O (universal port multiplexer)		1	1
P20	P20	I/O	Hi-Z	-	I/O port		1	1
	UPMUX	I/O			User-selected I/O (universal port multiplexer)		1	1
P21	P21	I/O	Hi-Z	_	I/O port		1	1
	UPMUX	I/O			User-selected I/O (universal port multiplexer)		1	1
P22	P22	I/O	Hi-Z	_	I/O port		1	1
	UPMUX	I/O	]		User-selected I/O (universal port multiplexer)		1	1
P23	P23	I/O	Hi-Z	_	I/O port		1	1
	UPMUX	I/O			User-selected I/O (universal port multiplexer)		1	1
P24	P24	1/0	Hi-Z	_	I/O port		1	1
	UPMUX	I/O			User-selected I/O (universal port multiplexer)		1	1
P40	P40	I/O	Hi-Z	-	I/O port	High drive-capability	1	1
	SEG0	0			LED segment output	Nch output	1	1
P41	P41	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	SEG1	0			LED segment output	Nch output	1	1
P42	P42	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	SEG2	0			LED segment output	Nch output	1	1
P43	P43	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	SEG3	0			LED segment output	Nch output	1	1
P44	P44	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	SEG4	0			LED segment output	Nch output	1	1
P45	P45	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	SEG5	0			LED segment output	Nch output	1	1
P46	P46	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	SEG6	0			LED segment output	Nch output	1	1
P47	P47	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	SEG7	0			LED segment output	Nch output	1	1
P50	P50	I/O	Hi-Z	-	I/O port	High drive-capability	1	1
	REMO	0			IR remote controller transmit data output	Pch output	1	1
	COM0	0			LED common output		1	1
P51	P50	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	CLPLS	0			IR remote controller clear pulse output	Pch output	1	1
	COM1	0			LED common output		1	1
P52	P50	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	COM2	0			LED common output	Pch output	1	1
P53	P50	1/0	Hi-Z	_	I/O port	High drive-capability	1	1
	СОМЗ	0			LED common output	Pch output	1	1
P54	P50	I/O	Hi-Z	_	I/O port	High drive-capability	1	1
	COM4	0			LED common output	Pch output	1	1
PD0	DST2	0	O (L)	_	On-chip debugger status output		1	1
	PD0	I/O			I/O port		1	1
PD1	DSIO	I/O	I (Pull-up)	-	On-chip debugger data input/output		1	1
	PD1	I/O			I/O port		1	1
PD2	DCLK	0	O (H)	_	On-chip debugger clock output		1	1
	PD2	0			Output port		1	1

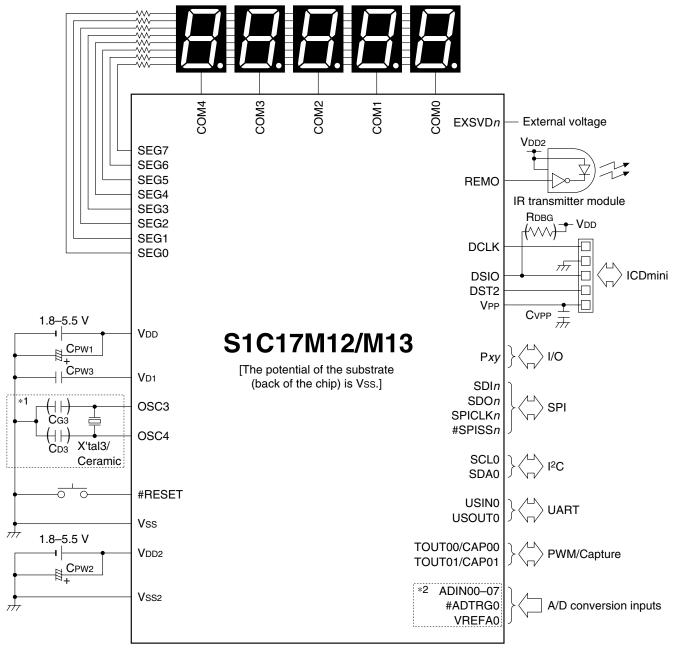
Pin/pad name	Assigned signal	I/O	Initial state	Tolerant fail-safe structure	Function	M M		S1C17M13
PD3	PD3	I/O	Hi-Z	_	I/O port	1	1	7
	OSC3	Α			OSC3 oscillator circuit input	1	1	/
PD4	PD4	I/O	Hi-Z	-	I/O port	1	1	/
	OSC4	Α			OSC3 oscillator circuit output	1	7	/

#### **Universal port multiplexer (UPMUX)**

The universal port multiplexer (UPMUX) allows software to select the peripheral circuit input/output function to be assigned to each pin from those listed below. Note, however, that a function cannot be assigned to two or more pins simultaneously.

Peripheral circuit	Signal to be assigned	I/O	Channel number n	Function
Synchronous serial interface	SDI <i>n</i>		n = 0, 1	SPIA Ch.n data input
(SPIA)	SDOn	0		SPIA Ch.n data output
	SPICLKn	I/O		SPIA Ch.n clock input/output
	#SPISSn	- 1		SPIA Ch.n slave-select input
I <sup>2</sup> C	SCLn	1/0	<i>n</i> = 0	I2C Ch.n clock input/output
(I2C)	SDAn	I/O		I2C Ch.n data input/output
UART	USINn	- 1	n = 0	UART3 Ch.n data input
(UART3)	USOUTn	0		UART3 Ch.n data output
16-bit PWM timer	TOUTn0/CAPn0	I/O	n = 0	T16B Ch.n PWM output/capture input 0
(T16B)	TOUTn1/CAPn1	I/O		T16B Ch.n PWM output/capture input 1

#### **■** Basic External Connection Diagram



- \*1:When OSC3 crystal/ceramic oscillator is selected
- \*2:Available only in the S1C17M13
- ( ): Do not mount components if unnecessary.

#### Sample external components

Symbol	Name	Recommended components		
X'tal3	Crystal resonator	CA-301 (4 MHz) manufactured by Seiko Epson Corporation		
Ceramic	Ceramic resonator	CSBLA_J (1 MHz) manufactured by Murata Manufacturing Co., Ltd.		
Cgз	OSC3 gate capacitor	Ceramic capacitor		
Срз	OSC3 drain capacitor	Ceramic capacitor		
C <sub>PW1</sub>	Bypass capacitor between Vss and VDD	Ceramic capacitor or electrolytic capacitor		
CPW2	Bypass capacitor between Vss2 and VDD2	Ceramic capacitor or electrolytic capacitor		
Срwз	Capacitor between Vss and VD1	Ceramic capacitor		
Rdbg	DSIO pull-up resistor	Thick film chip resistor		
Сурр	Capacitor between Vss and VPP	Ceramic capacitor		

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